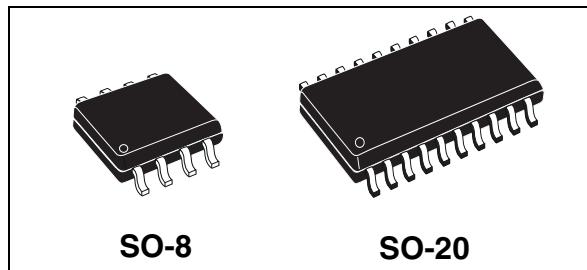


## Features

- Operating DC supply voltage range 5.6 V to 31 V
- Very low quiescent current with watchdog disabled
- Precision output voltage (3%)
- Low drop voltage (180 mV typ at  $I_o = 150 \text{ mA}$ )
- Reset circuit sensing the output voltage down to 1 V
- Programmable reset delay with external capacitor
- Watchdog disable input
- Programmable watchdog timer with external capacitor
- Thermal shutdown and short circuit protection
- Wide temperature range ( $T_j = -40^\circ\text{C}$  to  $150^\circ\text{C}$ )



## Description

The L4989M and L4989MD are monolithic integrated 5 V voltage regulators with a low drop voltage at currents up to 150 mA.

The output voltage regulating element consists in a p-channel MOS and the regulation is performed regardless of input voltage transients up to 40 V. The high precision of the output voltage is obtained with a pre-trimmed reference voltage.

The devices are protected against short circuit and an overtemperature protection switches off the devices in case of extremely high power dissipation.

The L4989M and L4989MD watchdogs are active when the Enable pin is high. Features like reset and watchdog make this devices particularly suitable to supply microprocessor systems in automotive applications.

**Table 1. Device summary**

Package	Order codes	
	Tube	Tape and reel
SO-8	L4989D	L4989D013TR
SO-20	L4989MD	L4989MD013TR

## Contents

<b>1</b>	<b>Block diagram and pin configuration</b>	<b>5</b>
<b>2</b>	<b>Electrical specifications</b>	<b>7</b>
2.1	Absolute maximum ratings	7
2.2	Thermal data	7
2.3	Electrical characteristics	8
<b>3</b>	<b>Application information</b>	<b>11</b>
3.1	Voltage regulator	11
3.2	Reset	11
3.3	Watchdog	12
<b>4</b>	<b>Package and packing information</b>	<b>13</b>
4.1	ECOPACK® packages	13
4.2	SO-8 package information	13
4.3	SO-20 package information	15
4.4	SO-8 packing information	16
4.5	SO-20 packing information	17
<b>5</b>	<b>Revision history</b>	<b>18</b>

## List of tables

Table 1.	Device summary .....	1
Table 2.	Pins description .....	5
Table 3.	Absolute maximum ratings .....	7
Table 4.	Thermal data.....	7
Table 5.	General.....	8
Table 6.	Reset .....	9
Table 7.	Watchdog .....	9
Table 8.	Watchdog Enable .....	10
Table 9.	SO-8 mechanical data .....	14
Table 10.	SO-20 mechanical data .....	15
Table 11.	Document revision history .....	18

## List of figures

Figure 1.	Block diagram . . . . .	5
Figure 2.	Pins configuration (top view) . . . . .	6
Figure 3.	Behavior of output current versus regulated voltage $V_o$ . . . . .	11
Figure 4.	Reset timing diagram . . . . .	12
Figure 5.	Watchdog timing diagram . . . . .	12
Figure 6.	SO-8 package dimensions . . . . .	13
Figure 7.	SO-20 package dimensions . . . . .	15
Figure 8.	SO-8 tube shipment (no suffix) . . . . .	16
Figure 9.	SO-8 tape and reel shipment (suffix "TR") . . . . .	16
Figure 10.	SO-20 tube shipment (no suffix) . . . . .	17
Figure 11.	SO-20 tape and reel shipment (suffix "TR") . . . . .	17

# 1 Block diagram and pin configuration

Figure 1. Block diagram

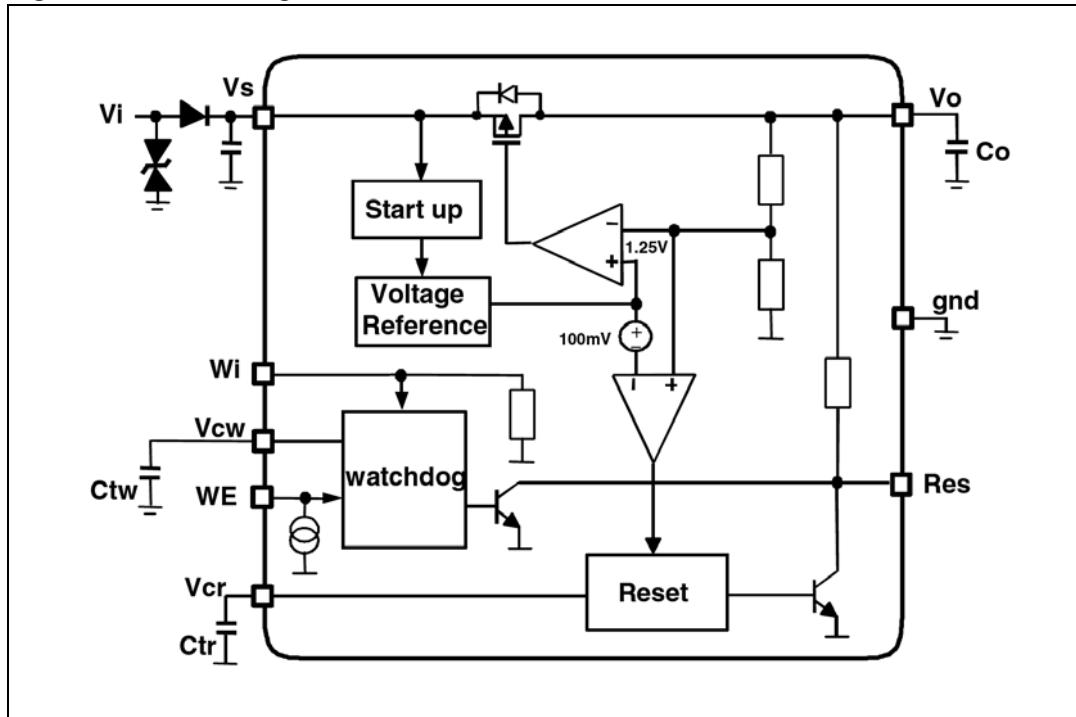
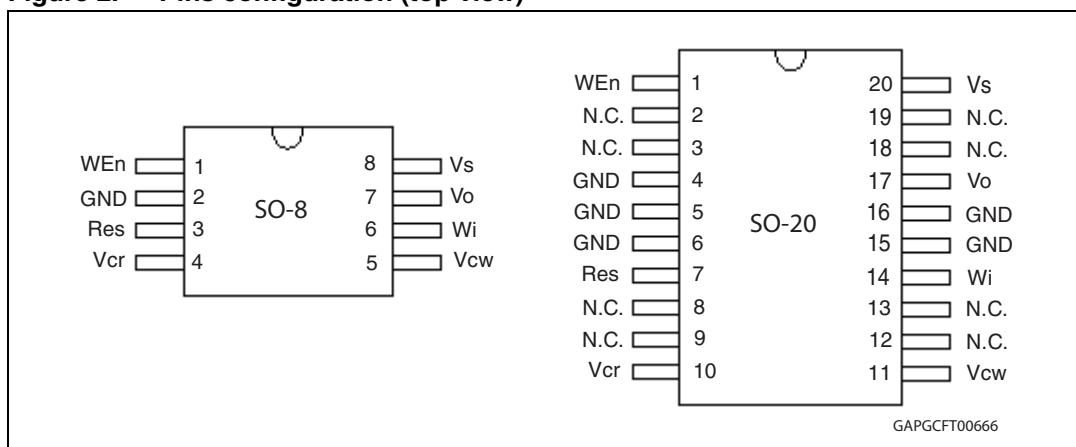


Table 2. Pins description

Pin name	SO-8(D)	SO-20(MD)	Function
WE <sub>n</sub>	1	1	Watchdog Enable input If high watchdog functionality is active
Gnd	2	4	Ground reference
Gnd		5, 6, 15, 16	Ground. Connected these pins to a heat spreader ground
Res	3	7	Reset output. It is pulled down when output voltage goes below V <sub>o_th</sub> or frequency at Wi is too low.
Vcr	4	10	Reset timing adjust. A capacitor between Vcr pin and gnd, sets the reset delay time (t <sub>rd</sub> )
Vcw	5	11	Watchdog timer adjust A capacitor between Vcw pin and gnd, sets the time response of the watchdog monitor.
Wi	6	14	Watchdog input. If the frequency at this input pin is too low, the Reset output is activated.

**Table 2.** Pins description (continued)

Pin name	SO-8(D)	SO-20(MD)	Function
V <sub>o</sub>	7	17	Voltage regulator output Block to ground with a capacitor >100nF (needed for regulator stability)
V <sub>S</sub>	8	20	Supply voltage Block to ground directly at IC pin with a capacitor
N.C.		2, 3, 8, 9, 12, 13, 18, 19	Not connected

**Figure 2.** Pins configuration (top view)

## 2 Electrical specifications

### 2.1 Absolute maximum ratings

**Table 3. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{Vsd}$	DC supply voltage	-0.3 to 40	V
$I_{Vsd}$	Input current	Internally limited	
$V_{Vo}$	DC output voltage	-0.3 to 6	V
$I_{Vo}$	DC output current	Internally limited	
$V_{Wi}$	Watchdog input voltage	-0.3 to $V_{Vo} + 0.3$	V
$V_{od}$	Open Drain output voltage	-0.3 to $V_{Vo} + 0.3$	V
$I_{od}$	Open Drain output current	Internally limited	
$V_{cr}$	Reset delay voltage	-0.3 to $V_{Vo} + 0.3$	V
$V_{cw}$	Watchdog delay voltage	-0.3 to $V_{Vo} + 0.3$	V
$V_{WEn}$	Watchdog Enable input voltage	-0.3 to 40	V
$T_j$	Junction temperature	-40 to 150	°C
$V_{ESD}$	ESD voltage level (HBM-MIL STD 883C)	±2	kV

**Note:** Maximum ratings are absolute ratings; exceeding any one of these values may cause permanent damage to the integrated circuit.

### 2.2 Thermal data

**Table 4. Thermal data**

Symbol	Parameter	S0-8	S0-12+4+4	Unit
$R_{th-jamb}$	Thermal resistance junction to ambient	130 to 180	50 <sup>(1)</sup>	°C/W

1. With 6 sq. cm on board heat sink.

## 2.3 Electrical characteristics

$V_S = 5.6 \text{ V to } 31 \text{ V}$ ,  $T_j = -40^\circ\text{C} \text{ to } +150^\circ\text{C}$  unless otherwise specified.

**Table 5. General**

Pin	Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
$V_o$	$V_{o\_ref}$	Output voltage	$V_S = 5.6 \text{ to } 31 \text{ V}$ ; $I_o = 1 \text{ to } 150 \text{ mA}$	4.85	5.0	5.15	V
$V_o$	$I_{short\_13}$	Short circuit current	$V_S = 13.5 \text{ V}^{(1)}$	160	210	250	mA
$V_o$	$I_{lim}$	Output current limitation	$V_S = 13.5 \text{ V}^{(1)}$	170	250	290	mA
$V_S, V_o$	$V_{line}$	Line regulation voltage	$V_S = 5.6 \text{ to } 31 \text{ V}$ ; $I_o = 1 \text{ to } 150 \text{ mA}$			25	mV
$V_o$	$V_{load}$	Load regulation voltage	$I_o = 1 \text{ to } 150 \text{ mA}$			25	mV
$V_S, V_o$	$V_{dp}$	Drop voltage	$I_o = 150 \text{ mA}$		180	400	mV
$V_S, V_o$	SVR	Ripple rejection	$f_r = 100 \text{ Hz}$	55			dB
$V_S, V_o$	$I_{qs\_1}$	Current consumption with watchdog not active $I_{qs\_1} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o < 1 \text{ mA}$ ; $WE_n = \text{low}$		69	115	µA
$V_S, V_o$	$I_{qs\_10}$	Current consumption with watchdog not active $I_{qs\_10} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o = 10 \text{ mA}$ ; $WE_n = \text{low}$		127	300	µA
$V_S, V_o$	$I_{qs\_50}$	Current consumption with watchdog not active $I_{qs\_50} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o = 50 \text{ mA}$ ; $WE_n = \text{low}$		498	900	µA
$V_S, V_o$	$I_{qs\_150}$	Current consumption with watchdog not active $I_{qs\_150} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o = 150 \text{ mA}$ ; $WE_n = \text{low}$		1.40	2	mA
$V_S, V_o$	$I_{qn\_1}$	Current consumption with watchdog active $I_{qn\_1} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o < 1 \text{ mA}$ ; $WE_n = \text{high}$		110	170	µA
$V_S, V_o$	$I_{qn\_10}$	Current consumption with watchdog active $I_{qn\_10} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o = 10 \text{ mA}$ ; $WE_n = \text{high}$		168	350	µA
$V_S, V_o$	$I_{qn\_50}$	Current consumption with watchdog active $I_{qn\_50} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o = 50 \text{ mA}$ ; $WE_n = \text{high}$		538	1000	µA
$V_S, V_o$	$I_{qn\_150}$	Current consumption with watchdog active $I_{qn\_150} = I_{VS} - I_o$	$V_S = 13.5 \text{ V}$ ; $I_o = 150 \text{ mA}$ ; $WE_n = \text{high}$		1.45	2	mA
	$T_w$	Thermal protection temperature		150		190	°C
	$T_w\_hy$	Thermal protection temperature hysteresis			10		°C

1. See [Figure 3](#).

**Table 6. Reset**

Pin	Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
Res	Vres_I	Reset output low voltage	R <sub>ext</sub> = 5 kΩ to V <sub>o</sub> ; V <sub>o</sub> > 1 V			0.4	V
Res	I <sub>Res_Ikg</sub>	Reset output high leakage current	V <sub>Res</sub> = 5 V			1	μA
Res	R <sub>Res</sub>	Pull up internal resistance	Versus V <sub>o</sub>	10	20	50	kΩ
Res	V <sub>o_th</sub>	Reset threshold voltage	V <sub>S</sub> = 5.6 to 31 V; I <sub>o</sub> = 1 to 150 mA	6%	8%	10%	Below V <sub>o_ref</sub>
Vcr	V <sub>rlth</sub>	Reset timing low threshold	V <sub>S</sub> = 13.5 V	10%	13%	16%	V <sub>o_ref</sub>
Vcr	V <sub>rhth</sub>	Reset timing high threshold	V <sub>S</sub> = 13.5 V	44%	47%	50%	V <sub>o_ref</sub>
Vcr	I <sub>cr</sub>	Charge current	V <sub>S</sub> = 13.5 V	8	15	30	μA
Vcr	I <sub>dr</sub>	Discharge current	V <sub>S</sub> = 13.5 V	8	15	30	μA
Res	T <sub>rr_2</sub>	Reset reaction time <sup>(1)</sup>	V <sub>o</sub> = V <sub>o_th</sub> - 100 mV	100	250	700	μs
Res	T <sub>rd</sub>	Reset delay time	V <sub>S</sub> = 13.5 V; Ctr = 1 nF	65	115	165	ms

1. When V<sub>o</sub> becomes lower than 4V, the reset reaction time decreases down to 2μs assuring a faster reset condition in this particular case.

**Table 7. Watchdog**

Pin	Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
Wi	Vih	Input high voltage	V <sub>S</sub> = 13.5 V	3.5			V
Wi	Vil	Input low voltage	V <sub>S</sub> = 13.5 V			1.5	V
Wi	Vih	Input hysteresis	V <sub>S</sub> = 13.5 V		500		mV
Wi	Rwi	Pull down resistor	V <sub>S</sub> = 13.5 V	30	100	250	kΩ
Vcw	Vwhth	High threshold	V <sub>S</sub> = 13.5 V	44%	47%	50%	V <sub>o_ref</sub>
Vcw	Vwlth	Low threshold	V <sub>S</sub> = 13.5 V	10%	13%	16%	V <sub>o_ref</sub>
Vcw	Icwc	Charge current	V <sub>S</sub> = 13.5 V; Vcw = 0.1 V	5	10	20	μA
Vcw	I cwd	Discharge current	V <sub>S</sub> = 13.5 V; Vcw = 2.5 V	1.25	2.5	5	μA
Vcw	Twop	Watchdog period	V <sub>S</sub> = 13.5 V; Ctw = 47 nF	20	40	80	ms
Res	twol	Watchdog output low time	V <sub>S</sub> = 13.5 V; Ctw = 47 nF	4	8	16	ms

**Table 8. Watchdog Enable**

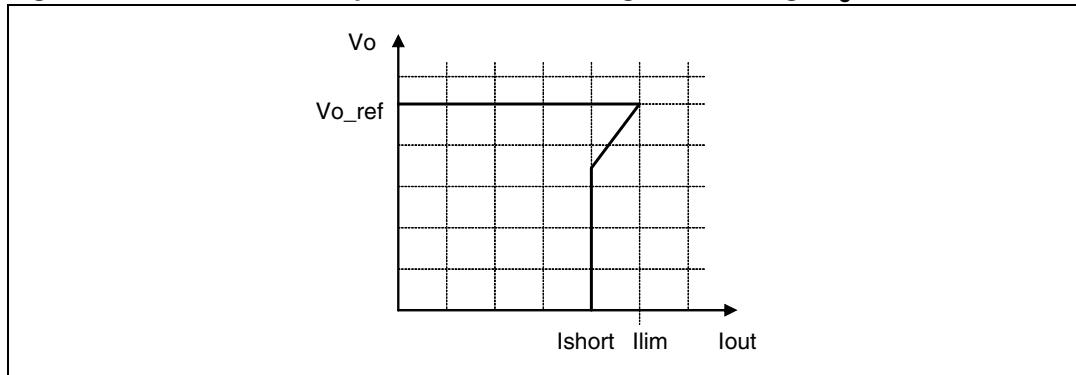
Pin	Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
WE <sub>n</sub>	V <sub>WE<sub>n</sub>_l</sub>	Enable input low voltage				1	V
WE <sub>n</sub>	V <sub>WE<sub>n</sub>_h</sub>	Enable input high voltage		3			V
WE <sub>n</sub>	V <sub>WE<sub>n</sub>_hy</sub>	Enable input hysteresis		600	920	1300	mV
WE <sub>n</sub>	I <sub>leak</sub>	Pull down current	V <sub>S</sub> = 13.5 V	1	2.5	5	μA

## 3 Application information

### 3.1 Voltage regulator

The voltage regulator uses a p-channel MOS transistor as a regulating element. With this structure a very low dropout voltage at current up to 150 mA is obtained. The output voltage is regulated up to transient input supply voltage of 40 V. No functional interruption due to over-voltage pulses is generated. The voltage Regulator is always active and not depending on the state of WE<sub>n</sub> input pin. A short circuit protection to GND is provided.

**Figure 3. Behavior of output current versus regulated voltage  $V_o$**



### 3.2 Reset

The reset circuit supervises the output voltage  $V_o$ . The  $V_{o\_th}$  reset threshold is defined with the internal reference voltage and a resistor output divider. If the output voltage becomes lower than  $V_{o\_th}$  then Res goes low with a reaction time  $t_{rr}$ . The reset low signal is guaranteed for an output voltage  $V_o$  greater than 1 V.

When the output voltage becomes higher than  $V_{o\_th}$  then Res goes high with a delay  $t_{rd}$ . This delay is obtained by an internal oscillator.

The oscillator period is given by:

$$T_{osc} = [(V_{rhth} - V_{rlth}) \times C_{tr}] / I_{cr} + [(V_{rhth} - V_{rlth}) \times C_{tr}] / I_{dr}$$

where:

$I_{cr}$ : is an internally generated charge current

$I_{dr}$ : is an internally generated discharge current

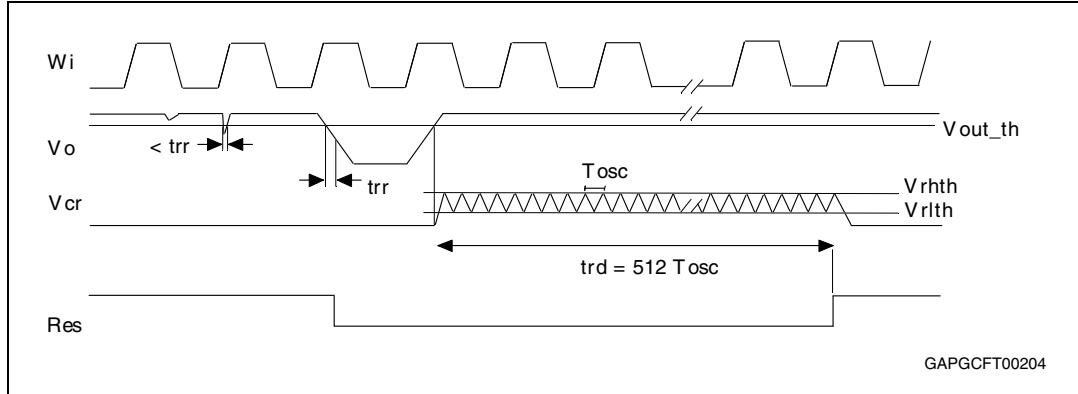
$V_{rhth}, V_{rlth}$ : are two voltages defined with the output voltage and a resistor output divider

$C_{tr}$ : is an external capacitance.

$t_{rd}$  is given by:

$$t_{rd} = 512 \times T_{osc}$$

The Reset is always active and not depending on the state of WE<sub>n</sub> input pin.

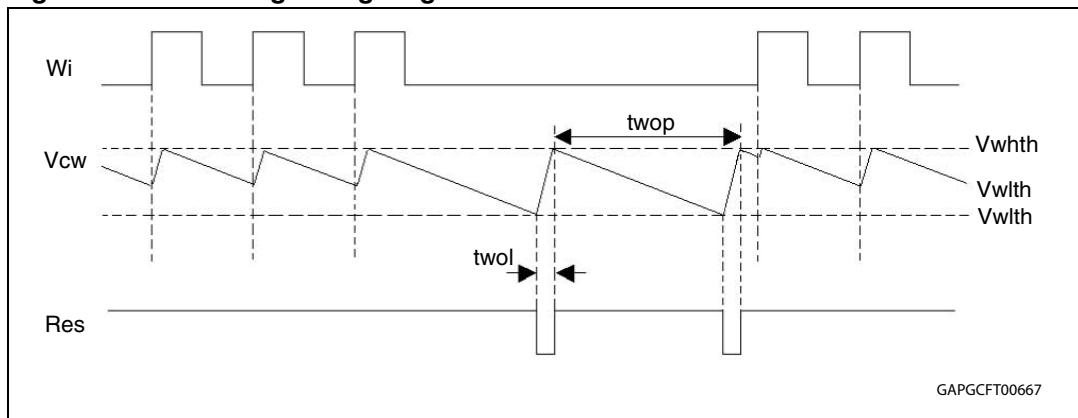
**Figure 4. Reset timing diagram**

### 3.3 Watchdog

A connected microcontroller is monitored by the watchdog input  $W_i$ . If pulses are missing, the Reset output pin is set to low. The pulse sequence time can be set within a wide range with the external capacitor,  $C_{tw}$ . The watchdog circuit discharges the capacitor  $C_{tw}$ , with the constant current  $I_{cwd}$ . If the lower threshold  $V_{wlth}$  is reached, a watchdog reset is generated. To prevent this the microcontroller must generate a positive edge during the discharge of the capacitor before the voltage has reached the threshold  $V_{wlth}$ . In order to calculate the minimum time  $t$ , during which the micro-controller must output the positive edge, the following equation can be used:

$$(V_{whth} - V_{wlth}) \times C_{tw} = I_{cwd} \times t$$

Every  $W_i$  positive edge switches the current source from discharging to charging. The same happens when the lower threshold is reached. When the voltage reaches the upper threshold,  $V_{whth}$ , the current switches from charging to discharging. The result is a saw-tooth voltage at the watchdog timer capacitor  $C_{tw}$ .

**Figure 5. Watchdog timing diagram**

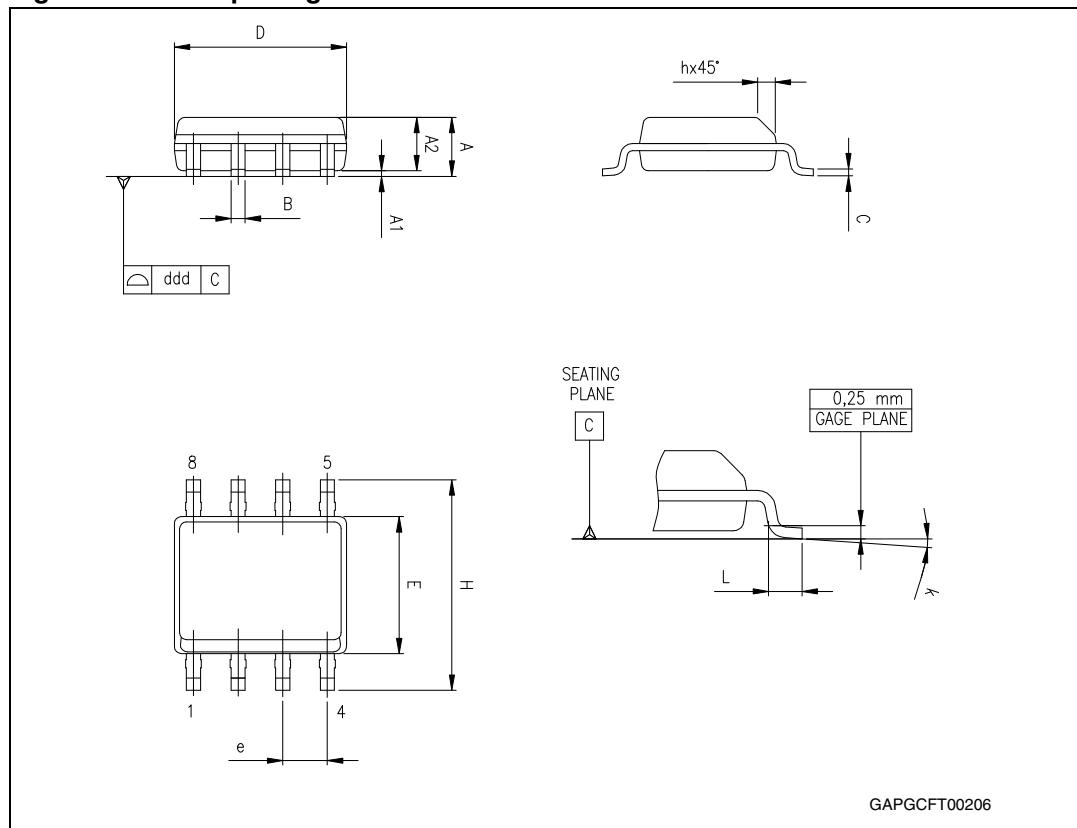
## 4 Package and packing information

### 4.1 ECOPACK® packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

### 4.2 SO-8 package information

Figure 6. SO-8 package dimensions



**Table 9. SO-8 mechanical data**

Symbol	Millimeters		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.28		0.48
c	0.17		0.23
D <sup>(1)</sup>	4.80	4.90	5.00
E	5.80	6.00	6.20
E1 <sup>(2)</sup>	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
k	0°		8°
ccc			0.10

1. Dimensions D does not include mold flash, protrusions or gate burrs. Mold flash, potrusions or gate burrs shall not exceed 0.15mm in total (both side).

2. Dimension "E1" does not include interlead flash or protrusions. Interlead flash or protrusions shall not exceed 0.25mm per side.

## 4.3 SO-20 package information

Figure 7. SO-20 package dimensions

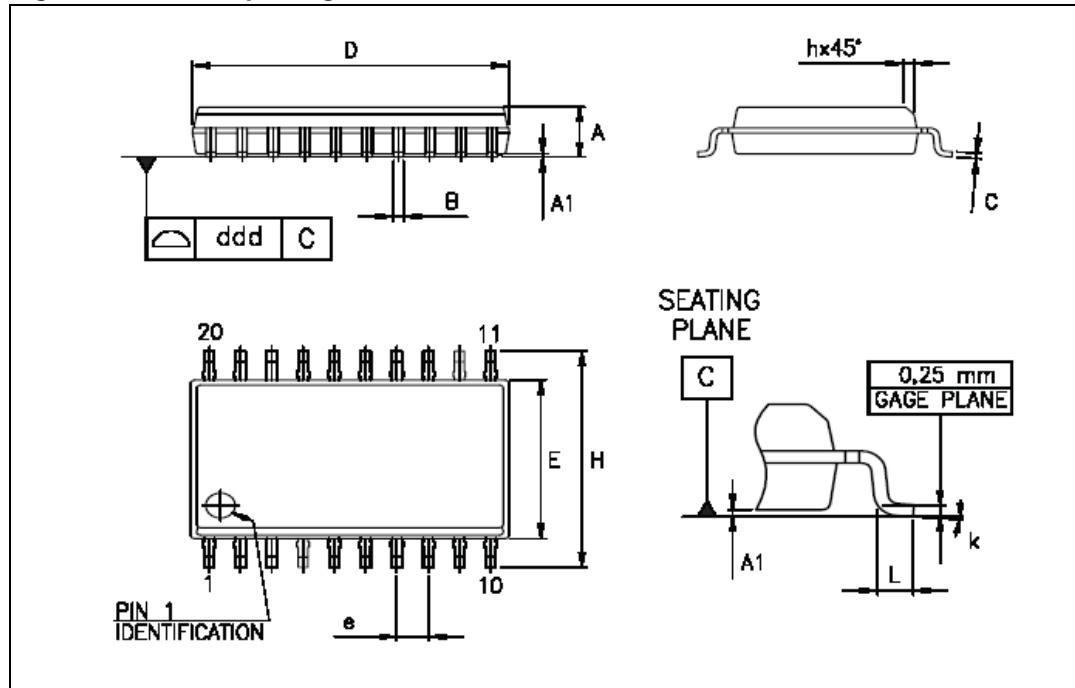


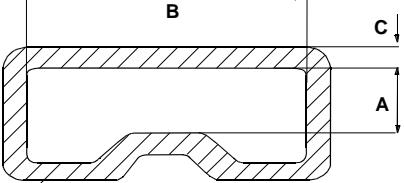
Table 10. SO-20 mechanical data

Symbol	Millimeters		
	Min.	Typ.	Max.
A	2.35		2.65
A1	0.10		0.30
B	0.33		0.51
C	0.23		0.32
D <sup>(1)</sup>	12.60		13.00
E	7.40		7.60
e		1.27	
H	10.0		10.65
h	0.25		0.75
L	0.40		1.27
k	0°		8°
ddd			0.10

1. "D" dimension does not include mold flash, protusions or gate burrs. Mold flash, protusions or gate burrs shall not exceed 0.15mm per side.

## 4.4 SO-8 packing information

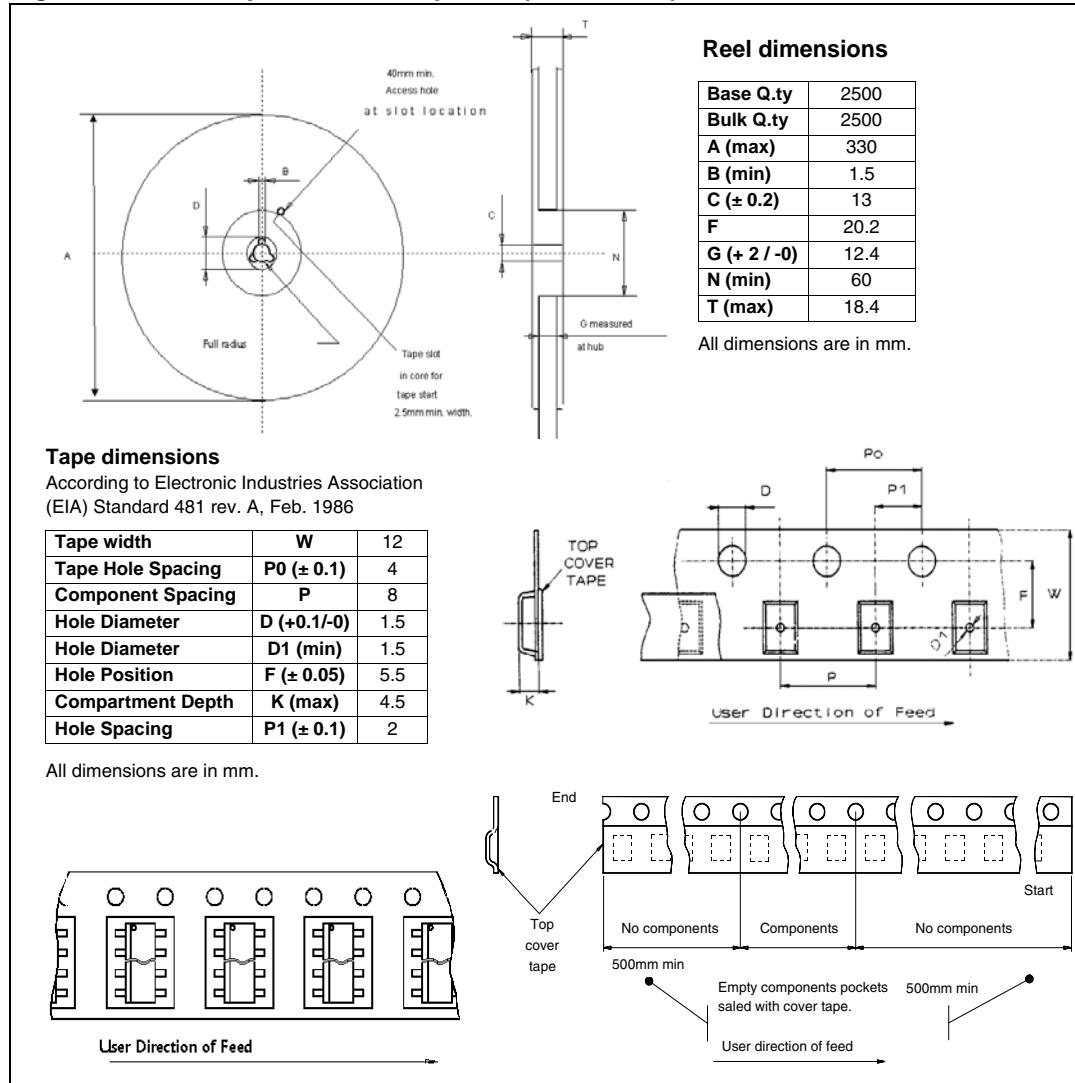
**Figure 8. SO-8 tube shipment (no suffix)**



<b>Base Q.ty</b>	100
<b>Bulk Q.ty</b>	2000
<b>Tube length (<math>\pm 0.5</math>)</b>	532
<b>A</b>	3.2
<b>B</b>	6
<b>C (<math>\pm 0.1</math>)</b>	0.6

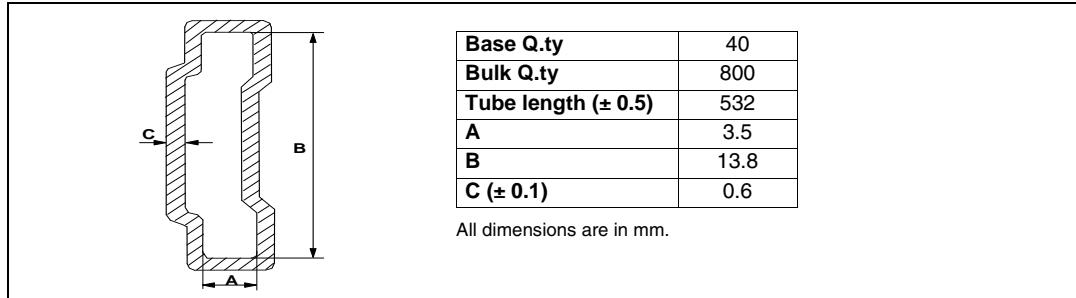
All dimensions are in mm.

**Figure 9. SO-8 tape and reel shipment (suffix "TR")**



## 4.5 SO-20 packing information

Figure 10. SO-20 tube shipment (no suffix)

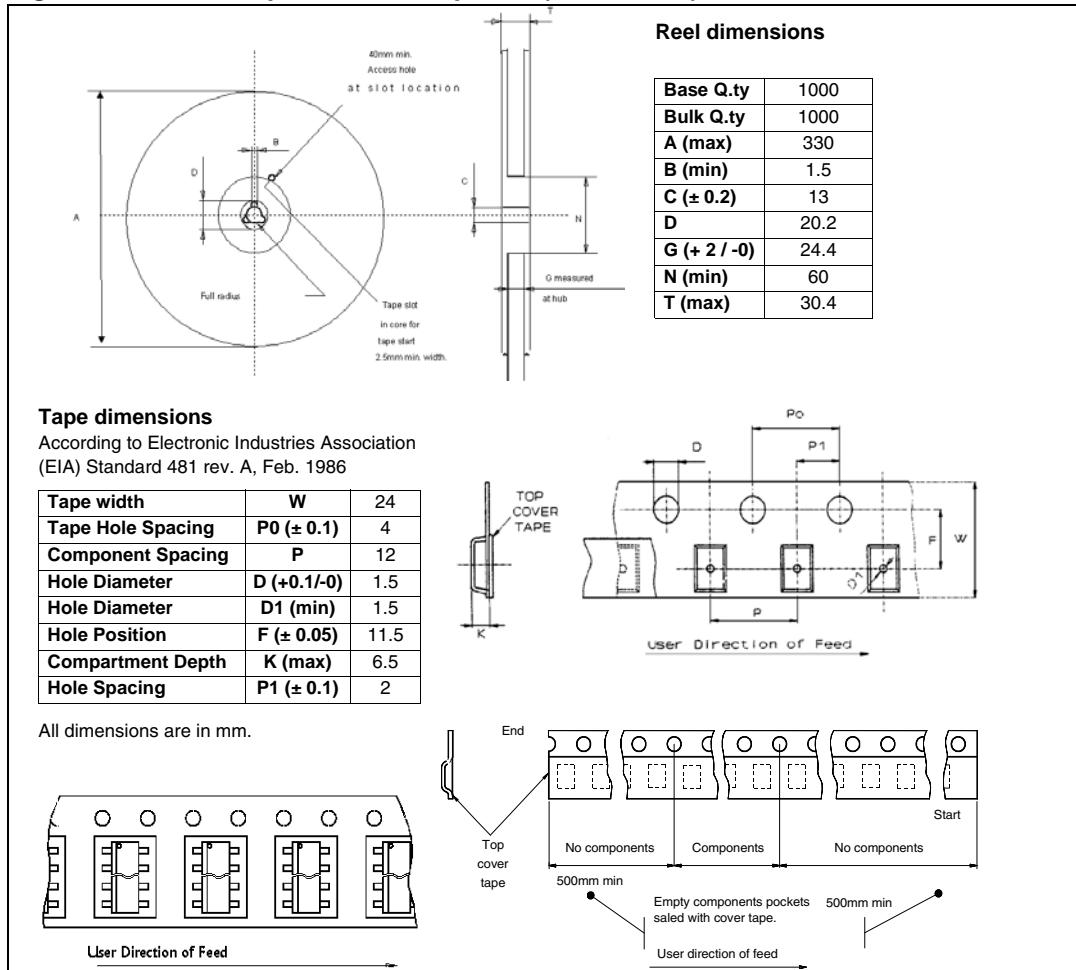


The diagram shows a cross-section of a tube with three dimensions labeled: A (width), B (height), and C (depth). To the right is a table of packing information:

Base Q.ty	40
Bulk Q.ty	800
Tube length ( $\pm 0.5$ )	532
A	3.5
B	13.8
C ( $\pm 0.1$ )	0.6

All dimensions are in mm.

Figure 11. SO-20 tape and reel shipment (suffix "TR")



**Reel dimensions**

Base Q.ty	1000
Bulk Q.ty	1000
A (max)	330
B (min)	1.5
C ( $\pm 0.2$ )	13
D	20.2
G (+ 2 / -0)	24.4
N (min)	60
T (max)	30.4

**Tape dimensions**  
According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb. 1986

Tape width	W	24
Tape Hole Spacing	P0 ( $\pm 0.1$ )	4
Component Spacing	P	12
Hole Diameter	D (+0.1/-0)	1.5
Hole Diameter	D1 (min)	1.5
Hole Position	F ( $\pm 0.05$ )	11.5
Compartment Depth	K (max)	6.5
Hole Spacing	P1 ( $\pm 0.1$ )	2

All dimensions are in mm.

**User Direction of Feed**

**Component Layout Diagram**

The diagram shows a top-down view of a tape with components arranged in a grid. Labels include P0, P1, D, F, W, K, and P. Arrows indicate the user direction of feed. Below the diagram, a schematic shows the tape being fed into a reeler.

## 5 Revision history

**Table 11. Document revision history**

Date	Revision	Changes
16-Apr-2012	1	Initial release. This document replace the L4989 datasheet.
19-Sep-2013	2	Updated Disclaimer.

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)